

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain Gate Voltage ($R_{GS}=1M\Omega$)	V_{DGR}	650	V
Gate-Source (GND) Voltage	V_{GS}	± 30	V
Drain Current Pulsed ⁽²⁾	I_{DM}	36.0	ADC
Single Pulsed Avalanche Energy ⁽³⁾	EAS	950	mJ
Continuous Drain Current ($T_C=25^\circ\text{C}$)	I_D	9.0	ADC
Continuous Drain Current ($T_C=100^\circ\text{C}$)	I_D	5.8	ADC
Maximum Supply Voltage	$V_{CC,MAX}$	30	V
Input Voltage Range	V_{FB}	-0.3 to V_{SD}	V
Total Power Dissipation	P_D	170	W
	Darting	1.33	W/ $^\circ\text{C}$
Operating Ambient Temperature	T_A	-25 to +85	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55 to +150	$^\circ\text{C}$

Notes:

1. $T_j = 25^\circ\text{C}$ to 150°C
2. Repetitive rating: Pulse width limited by maximum junction temperature
3. $L = 20\text{mH}$, $V_{DD} = 50\text{V}$, $R_G = 27\Omega$, starting $T_j = 25^\circ\text{C}$

Electrical Characteristics (SFET part)

(Ta=25°C unless otherwise specified)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =50μA	650	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =Max., Rating, V _{GS} =0V	-	-	50	μA
		V _{DS} =0.8Max., Rating, V _{GS} =0V, T _C =125°C	-	-	200	μA
Static Drain-Source on Resistance ^(Note)	R _{DS(ON)}	V _{GS} =10V, I _D =4.5A	-	0.96	1.2	Ω
Forward Transconductance ^(Note)	g _{fs}	V _{DS} =15V, I _D =4.5A	5.0	-	-	S
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =25V, f=1MHz	-	1750	-	pF
Output Capacitance	C _{oss}		-	190	-	
Reverse Transfer Capacitance	C _{rss}		-	78	-	
Turn on Delay Time	t _{d(on)}	V _{DD} =0.5BV _{DSS} , I _D =9.0A (MOSFET switching time are essentially independent of operating temperature)	-	20	50	nS
Rise Time	t _r		-	23	55	
Turn Off Delay Time	t _{d(off)}		-	85	180	
Fall Time	t _f		-	30	70	
Total Gate Charge (Gate-Source+Gate-Drain)	Q _g	V _{GS} =10V, I _D =9.0A, V _{DS} =0.5BV _{DSS} (MOSFET switching time are essentially independent of operating temperature)	-	74	75	nC
Gate-Source Charge	Q _{gs}		-	12	-	
Gate-Drain (Miller) Charge	Q _{gd}		-	35.4	-	

Note:

1. Pulse test: Pulse width ≤ 300μs, duty cycle ≤ 2%

2. $S = \frac{1}{R}$

Electrical Characteristics (Control Part) (Continued)

(Ta=25°C unless otherwise specified)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
UVLO SECTION						
Start Threshold Voltage	V _{START}	-	14	15	16	V
Stop Threshold Voltage	V _{STOP}	After turn on	9	10	11	V
OSCILLATOR SECTION						
Initial Accuracy	F _{OSC}	Ta=25°C	61	67	73	kHz
Frequency Change With Temperature ⁽²⁾	$\Delta F/\Delta T$	-25°C ≤ Ta ≤ +85°C	-	±5	±10	%
Maximum Duty Cycle	D _{max}	-	74	77	80	%
FEEDBACK SECTION						
Feedback Source Current	I _{FB}	Ta=25°C, 0V ≤ V _{fb} ≤ 3V	0.7	0.9	1.1	mA
Shutdown Feedback Voltage	V _{SD}	-	6.9	7.5	8.1	V
Shutdown Delay Current	I _{delay}	Ta=25°C, 5V ≤ V _{fb} ≤ V _{SD}	4.0	5.0	6.0	μA
SOFT START SECTION						
Soft Start Voltage	V _{SS}	V _{FB} = 2V	4.7	5.0	5.3	V
Soft Start Current	I _{SS}	Sync & S/S=GND	0.8	1.0	1.2	mA
REFERENCE SECTION						
Output Voltage ⁽¹⁾	V _{ref}	Ta=25°C	4.80	5.00	5.20	V
Temperature Stability ⁽¹⁾⁽²⁾	V _{ref} /ΔT	-25°C ≤ Ta ≤ +85°C	-	0.3	0.6	mV/°C
CURRENT LIMIT (SELF-PROTECTION) SECTION						
Peak Current Limit	I _{OVER}	Max. inductor current	5.28	6.00	6.72	A
PROTECTION SECTION						
Thermal Shutdown Temperature (T _j) ⁽¹⁾	T _{SD}	-	140	160	-	°C
Over Voltage Protection Voltage	V _{OV}	-	23	25	28	V
TOTAL DEVICE SECTION						
Start-Up Current	I _{START}	V _{CC} =14V	0.1	0.3	0.4	mA
Operating Supply Current (Control Part Only)	I _{OP}	Ta=25°C	6	12	18	mA
V _{CC} Zener Voltage	V _Z	I _{CC} =20mA	30	32.5	35	V

Notes:

1. These parameters, although guaranteed, are not 100% tested in production
2. These parameters, although guaranteed, are tested in EDS (wafer test) process
3. The amplitude of the sync. pulse is recommended to be between 2V and 3V for stable sync. function.

Typical Performance Characteristics

(These characteristic graphs are normalized at $T_a=25^{\circ}\text{C}$)

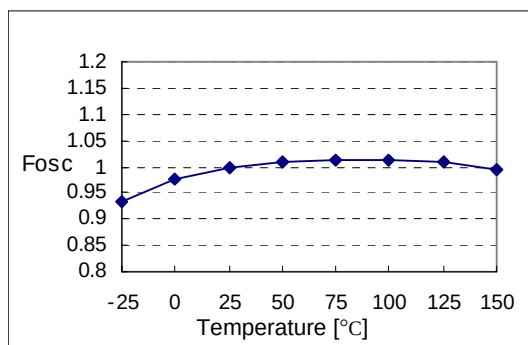


Figure 1. Operating Frequency

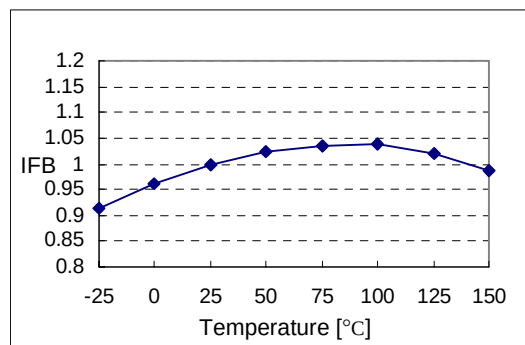


Figure 2. Feedback Source Current

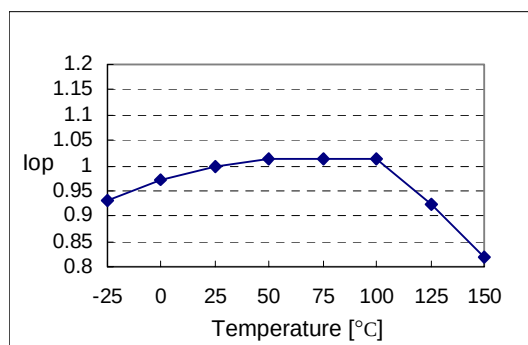


Figure 3. Operating Supply Current

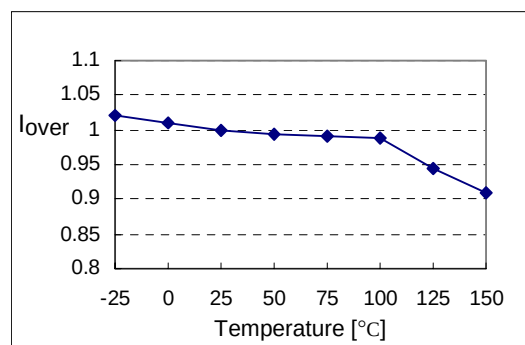


Figure 4. Peak Current Limit

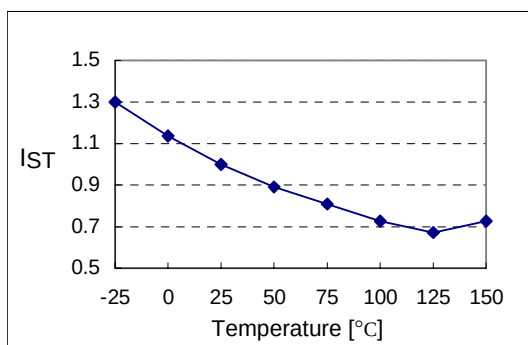


Figure 5. Start up Current

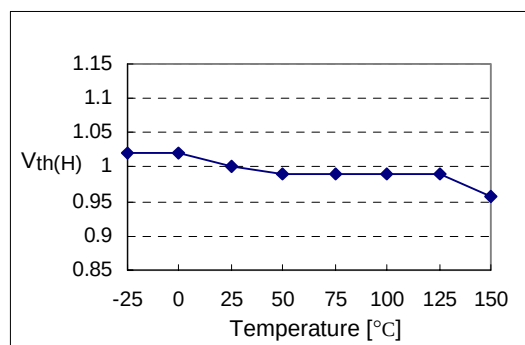


Figure 6. Start Threshold Voltage

Typical Performance Characteristics (Continued)

(These characteristic graphs are normalized at $T_a=25^{\circ}\text{C}$)

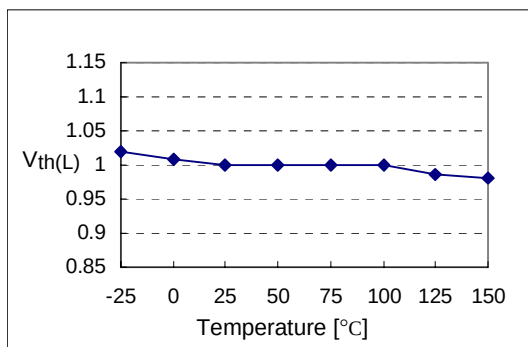


Figure 7. Stop Threshold Voltage

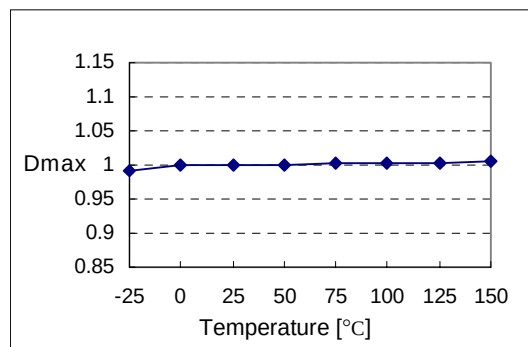


Figure 8. Maximum Duty Cycle

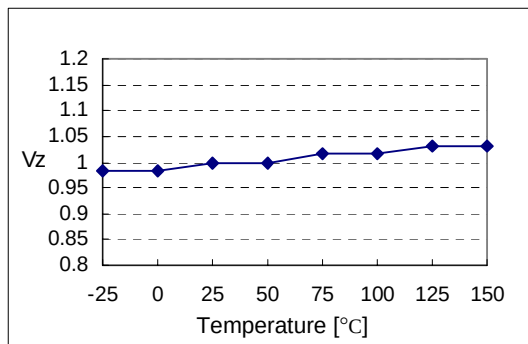


Figure 9. VCC Zener Voltage

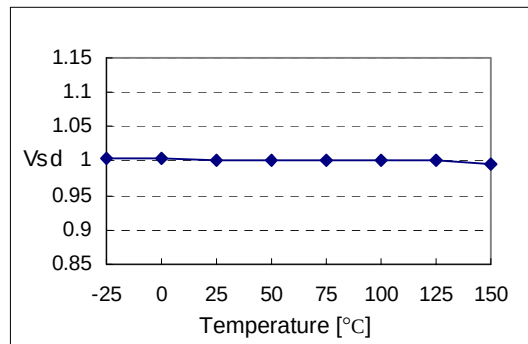


Figure 10. Shutdown Feedback Voltage

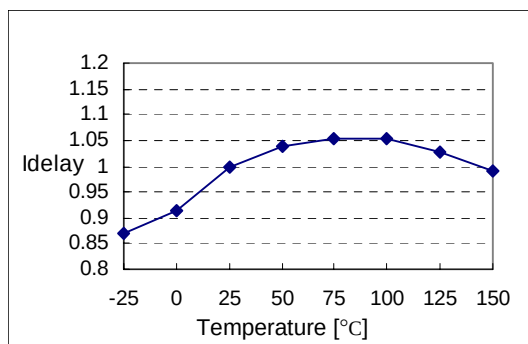


Figure 11. Shutdown Delay Current

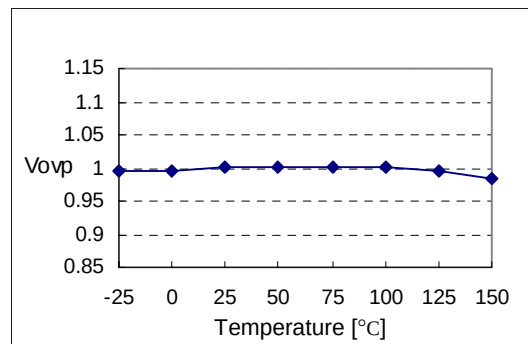


Figure 12. Over Voltage Protection

Typical Performance Characteristics (Continued)

(These characteristic groups are normalized at $T_a=25^\circ\text{C}$)

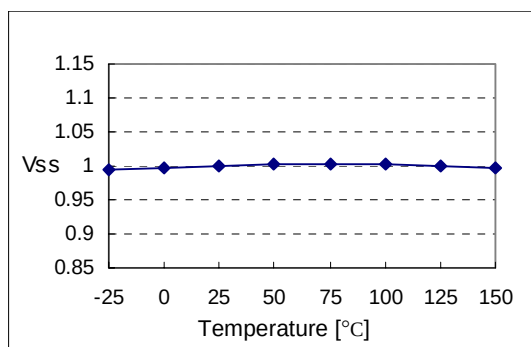


Figure 13. Soft Start Voltage

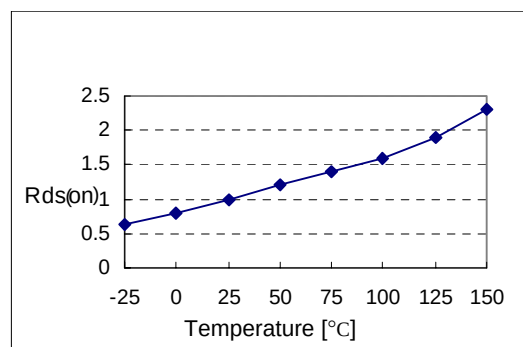
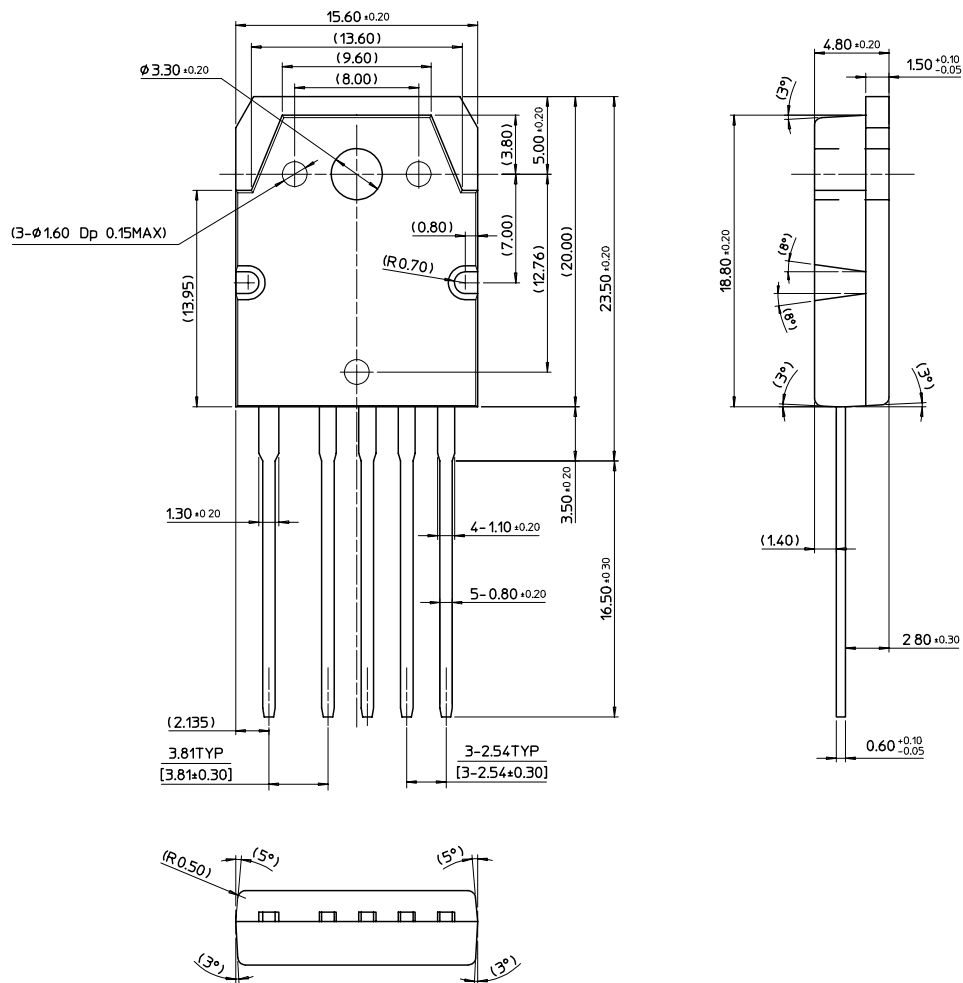


Figure 14. Static Drain Source on Resistance

Package Dimensions

TO-3P-5L



Ordering Information

Product Number	Package	Rating	Operating Temperature
KA1M0965RTU	TO-3P-5L	650V, 9A	-25°C to +85°C
KA1M0965RYDTU	TO-3P-5L(Forming)		

TU : Non Forming Type

YDTU : Forming Type

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